



2DB1697

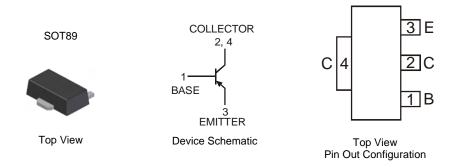
12V LOW V_{CE(sat)} PNP SURFACE MOUNT TRANSISTOR

Features

- Epitaxial Planar Die Construction
- Ideally Suited for Automated Assembly Processes
- Ideal for Medium Power Switching or Amplification Applications
- Complementary NPN Type Available (2DD2661)
- Totally Lead-Free & Fully RoHS compliant (Note 1)
- Halogen and Antimony Free. "Green" Device (Note 2)

Mechanical Data

- Case: SOT89
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish Matte Tin annealed over Copper leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208
- Weight: 0.052 grams (approximate)



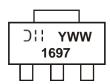
Ordering Information (Note 3)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
2DB1697-13	1697	13	12	2500

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 3. For packaging details, go to our website at http://www.diodes.com.

Marking Information



1697 = Product Type Marking Code YWW = Date Code Marking Y = Last digit of year (ex: 8 = 2008) WW = Week code (01 - 53)

April 2012

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Maximum Ratings @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V_{CBO}	-15	V
Collector-Emitter Voltage	$V_{\sf CEO}$	-12	V
Emitter-Base Voltage	V_{EBO}	-6	V
Peak Pulse Current	I _{CM}	-4	Α
Continuous Collector Current	lc	-2	А

Thermal Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 4)	P_{D}	0.9	W
Thermal Resistance, Junction to Ambient Air (Note 4)	$R_{ heta JA}$	139	°C/W
Power Dissipation (Note 5)	P_{D}	2	W
Thermal Resistance, Junction to Ambient Air (Note 5)	$R_{ heta JA}$	62.5	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Electrical Characteristics @TA = 25°C unless otherwise specified

Characteristic	Symbol	Min	Тур	Max	Unit	Conditions
OFF CHARACTERISTICS						
Collector-Base Breakdown Voltage	V _{(BR)CBO}	-15	_	_	V	$I_C = -100 \mu A, I_E = 0$
Collector-Emitter Breakdown Voltage (Note 6)	V _{(BR)CEO}	-12		_	V	$I_C = -10 \text{mA}, I_B = 0$
Emitter-Base Breakdown Voltage	V _{(BR)EBO}	-6	_	_	V	$I_E = -100 \mu A, I_C = 0$
Collector Cut-Off Current	I _{CBO}	_	_	-0.1	μΑ	$V_{CB} = -15V, I_{E} = 0$
Emitter Cut-Off Current	I _{EBO}	_	_	-0.1	μΑ	$V_{EB} = -6V, I_{C} = 0$
ON CHARACTERISTICS (Note 6)						
Collector-Emitter Saturation Voltage	V _{CE(SAT)}		-65	-180	mV	$I_C = -1A$, $I_B = -50mA$
DC Current Gain	h _{FE}	270	_	680	_	$V_{CE} = -2V, I_{C} = -200 \text{mA}$
SMALL SIGNAL CHARACTERISTICS						
Output Capacitance	C _{obo}	_	40	_	pF	$V_{CB} = -10V, I_E = 0,$ f = 1MHz
Current Gain-Bandwidth Product	f _T		140	_	MHz	$V_{CE} = -2V, I_{C} = -100mA,$ f = 100MHz

- 4. Device mounted on FR-4 PCB with minimum recommended pad layout.
 5. Device mounted on FR-4 PCB with 1 inch² copper pad layout.
- 6. Measured under pulsed conditions. Pulse width = $300\mu s$. Duty cycle $\leq 2\%$.



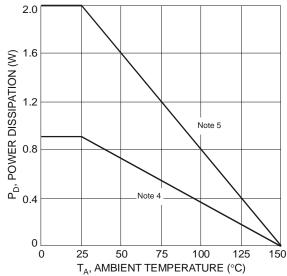
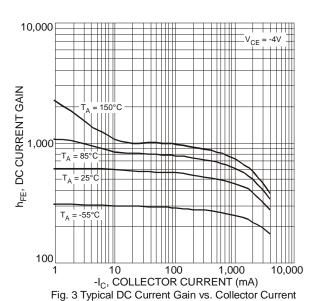


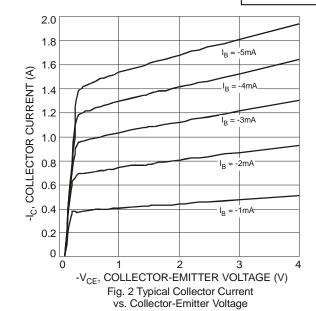
Fig. 1 Power Dissipation vs. Ambient Temperature



1.2 | V_{CE} = -4V | V_{CE} = -4

Fig. 5 Typical Base-Emitter Turn-On Voltage

vs. Collector Current



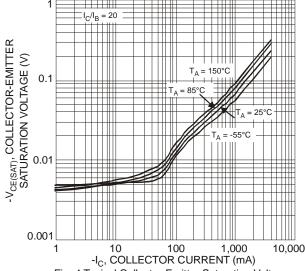


Fig. 4 Typical Collector-Emitter Saturation Voltage vs. Collector Current

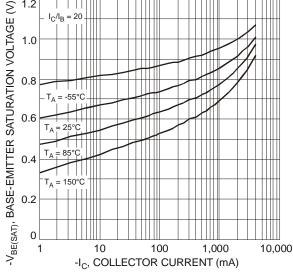
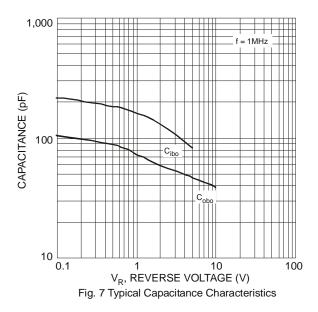
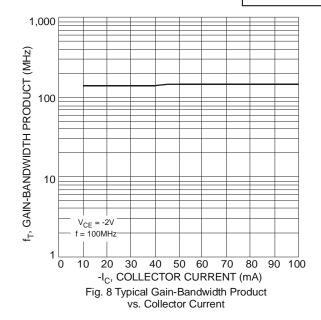


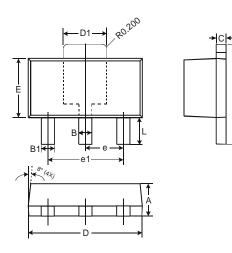
Fig. 6 Typical Base-Emitter Saturation Voltage vs. Collector Current

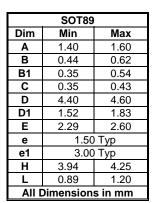




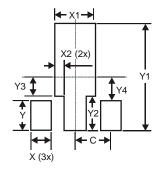


Package Outline Dimensions





Suggested Pad Layout



Dimensions	Value (in mm)			
Х	0.900			
X1	1.733			
X2	0.416			
Υ	1.300			
Y1	4.600			
Y2	1.475			
Y3	0.950			
Y4	1.125			
С	1.500			



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